

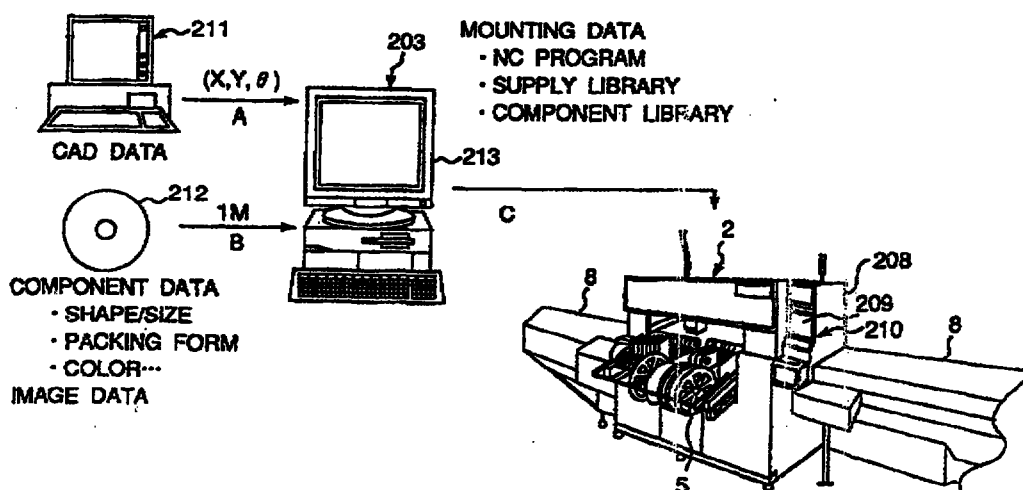
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(54) Title: METHOD AND APPARATUS FOR FORMING MOUNTING DATA, AND STORAGE MEDIUM USED THEREFOR, AND METHOD AND APPARATUS FOR MOUNTING COMPONENTS USING THE SAME



(57) Abstract

A method for forming mounting data, includes reading component text data corresponding to to-be-mounted components of individual mounting positions stored in a component electronic catalog, according to mounting-position data including mounting angles relating to the mounting positions formed on the to-be-mounted components, by using the component electronic catalog that has stored image data concerning various types of components including the to-be-mounted components as well as component text data necessary for component mounting including configurations and dimensions of the components, and forming mounting data for a mounter to receive components and mount them to specified mounting positions according to the mounting-position data as well as the component text data read for the individual mounting components concerning the to-be-mounted components corresponding to the mounting-position data.